

# **MOSFET**

### OptiMOS<sup>™</sup> 6 Power-Transistor, 135 V

#### **Features**

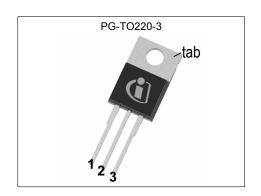
- N-channel, normal level
- Very low on-resistance R<sub>DS(on)</sub>
- Excellent gate charge x R<sub>DS(on)</sub> product (FOM) Very low reverse recovery charge (Q<sub>rr</sub>)
- 100% avalanche tested
- 175°C operating temperature
- Optimized for motor drives and battery powered applications
  Pb-free lead plating; RoHS compliant
  Halogen-free according to IEC61249-2-21

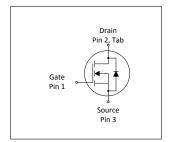


Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters** 

Parameter	Value	Unit
V <sub>DS</sub>	135	V
R <sub>DS(on),max</sub>	7.3	mΩ
I <sub>D</sub>	98	A
Qoss	75	nC
Q <sub>G</sub> (0V10V)	43	nC
Q <sub>rr</sub> (500A/µs)	81	nC











Type / Ordering Code	Ordering Code Package		Related Links
IPP073N13NM6	PG-TO220-3	073N13N6	-

# OptiMOS<sup>™</sup> 6 Power-Transistor, 135 V



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# OptiMOS<sup>™</sup> 6 Power-Transistor, 135 V IPP073N13NM6



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatav	Cumbal	Values			11	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	- - - -	- - -	98 69 65 15	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =8 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =40 °C/W <sup>2)</sup>	
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	392	Α	T <sub>C</sub> =25 °C	
Avalanche current, single pulse4)	I <sub>AS</sub>	-	-	40	Α	T <sub>C</sub> =25 °C	
Avalanche energy, single pulse <sup>4)</sup>	E <sub>AS</sub>	-	-	185	mJ	$I_{\rm D}$ =22 A, $R_{\rm GS}$ =25 $\Omega$	
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-	
Power dissipation	P <sub>tot</sub>	-	-	158 3.8	W	T <sub>C</sub> =25 °C T <sub>A</sub> =25 °C, R <sub>THJA</sub> =40 °C/W <sup>2)</sup>	
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	175	°C	-	

#### 2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition	
Parameter	Syllibol	Min.	Тур.	Max.	Oilit	Note / Test Condition	
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	0.95	°C/W	-	
Thermal resistance, junction - ambient, 6 cm² cooling area²)	R <sub>thJA</sub>	-	-	40	°C/W	-	
Thermal resistance, junction - ambient, minimal footprint	R <sub>thJA</sub>	-	-	62	°C/W	-	

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

# OptiMOS<sup>™</sup> 6 Power-Transistor, 135 V IPP073N13NM6



### 3 Electrical characteristics

at T<sub>j</sub>=25 °C, unless otherwise specified

**Table 4** Static characteristics

Daniel de la constante de la c	O. was boat		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	135	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	2.5	3.0	3.5	V	$V_{\rm DS}$ = $V_{\rm GS}$ , $I_{\rm D}$ =73 $\mu$ A	
Zero gate voltage drain current	I <sub>DSS</sub>	-	1 10	10 100	μΑ	V <sub>DS</sub> =108 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =108 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C	
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	
Drain-source on-state resistance <sup>1)</sup>	R <sub>DS(on)</sub>	- - -	6.1 6.5 6.9	7.0 7.3 8.3	mΩ	V <sub>GS</sub> =15 V, I <sub>D</sub> =40 A V <sub>GS</sub> =10 V, I <sub>D</sub> =40 A V <sub>GS</sub> =8 V, I <sub>D</sub> =20 A	
Gate resistance <sup>2)</sup>	R <sub>G</sub>	-	0.8	1.2	Ω	-	
Transconductance <sup>2)</sup>	<b>g</b> fs	39	77	-	S	$ V_{DS}  \ge 2 I_D R_{DS(on)max}, I_D = 40 A$	

Table 5 Dynamic characteristics

Damanastan	Or male al		Values			Nets / Test Ossalition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance <sup>2)</sup>	C <sub>iss</sub>	-	2900	3800	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =68 V, f=1 MHz	
Output capacitance <sup>2)</sup>	Coss	-	590	770	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =68 V, f=1 MHz	
Reverse transfer capacitance <sup>2)</sup>	C <sub>rss</sub>	-	11	19	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =68 V, f=1 MHz	
Turn-on delay time	t <sub>d(on)</sub>	-	12	-	ns	$V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$	
Rise time	t <sub>r</sub>	-	6.0	-	ns	$V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$	
Turn-off delay time	$t_{ m d(off)}$	-	18	-	ns	$V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$	
Fall time	t <sub>f</sub>	-	6.2	-	ns	$V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$	

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<sup>&</sup>lt;sup>1)</sup> R<sub>DS(on)</sub> is specified at a distance of 1.8 mm distance to the package body; mounting at a larger distance increases the overall package resistance of approximately 0.04 mOhm/mm per leg.
<sup>2)</sup> Defined by design. Not subject to production test.

# OptiMOS<sup>™</sup> 6 Power-Transistor, 135 V IPP073N13NM6



Table 6 Gate charge characteristics<sup>1)</sup>

Davamatav	Sumb al		Values			Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge <sup>2)</sup>	Q <sub>gs</sub>	-	13	17	nC	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge at threshold	$Q_{g(th)}$	-	8.7	-	nC	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge <sup>2)</sup>	Q <sub>gd</sub>	-	8.7	13	nC	V <sub>DD</sub> =68 V, I <sub>D</sub> =20 A, V <sub>GS</sub> =0 to 10 V	
Switching charge	Q <sub>sw</sub>	-	13	-	nC	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total <sup>2)</sup>	Qg	-	43	56	nC	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V	
Gate plateau voltage	V <sub>plateau</sub>	-	4.5	-	V	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total, sync. FET	Q <sub>g(sync)</sub>	-	39	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 10 V	
Output charge <sup>2)</sup>	Q <sub>oss</sub>	-	75	98	nC	V <sub>DS</sub> =68 V, V <sub>GS</sub> =0 V	

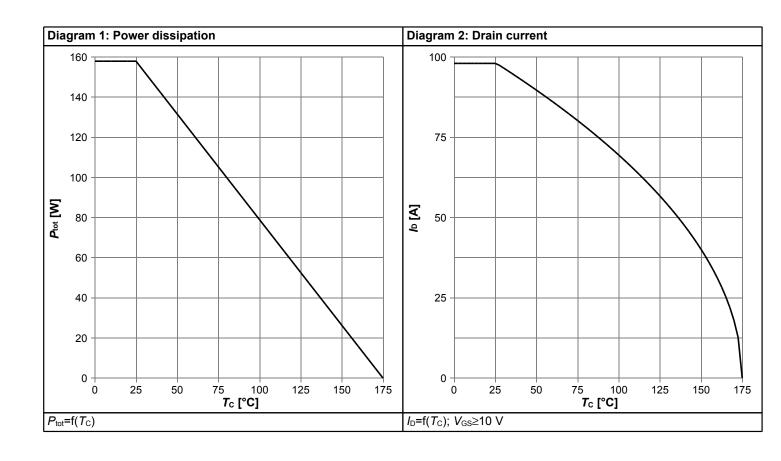
### Table 7 Reverse diode

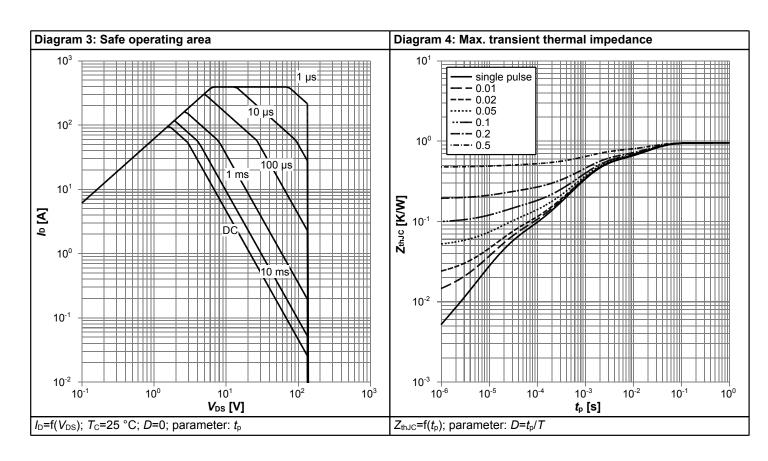
Doromotor	Cumbal	Values			l lmit	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	98	Α	T <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	392	Α	T <sub>C</sub> =25 °C	
Diode forward voltage	$V_{\mathrm{SD}}$	-	0.87	1	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =40 A, T <sub>j</sub> =25 °C	
Reverse recovery time <sup>2)</sup>	<i>t</i> <sub>rr</sub>	-	26	52	ns	V <sub>R</sub> =68 V, I <sub>F</sub> =20 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =500 A/μs	
Reverse recovery charge <sup>2)</sup>	Qrr	-	81	162	nC	$V_R$ =68 V, $I_F$ =20 A, $di_F/dt$ =500 A/ $\mu$ s	

 $<sup>^{1)}</sup>$  See "Gate charge waveforms" for parameter definition  $^{2)}$  Defined by design. Not subject to production test.

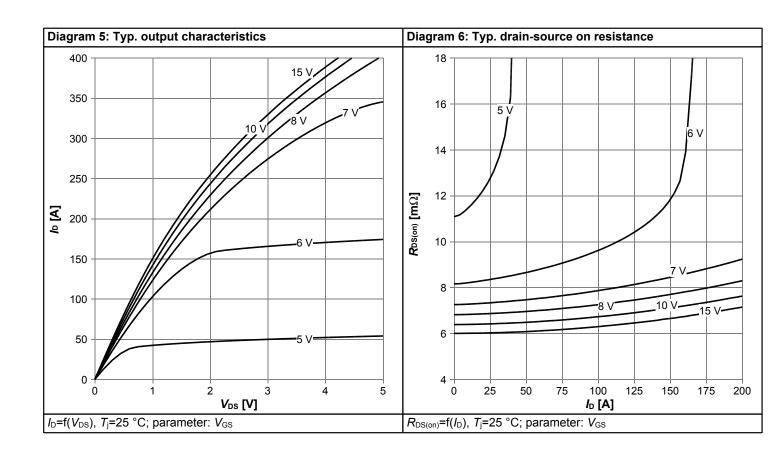


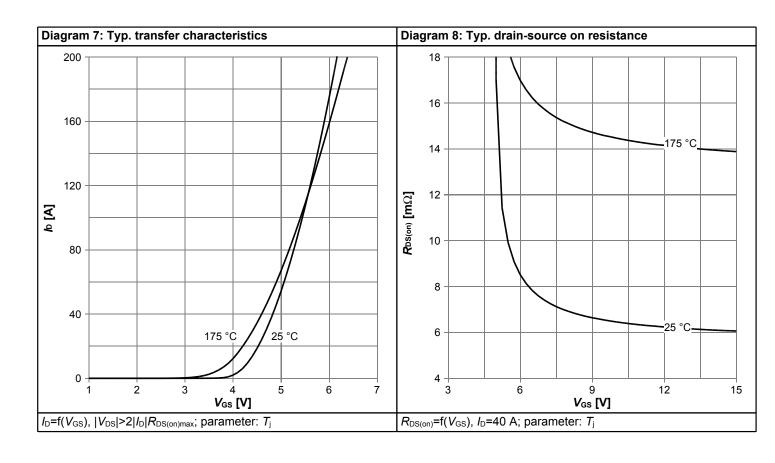
# 4 Electrical characteristics diagrams



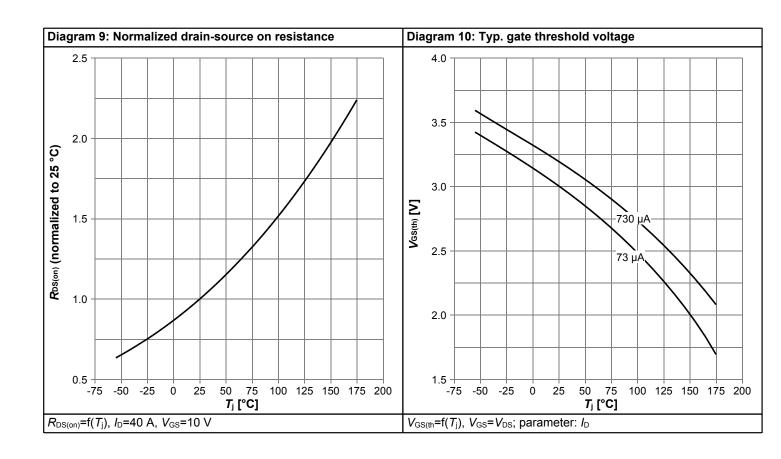


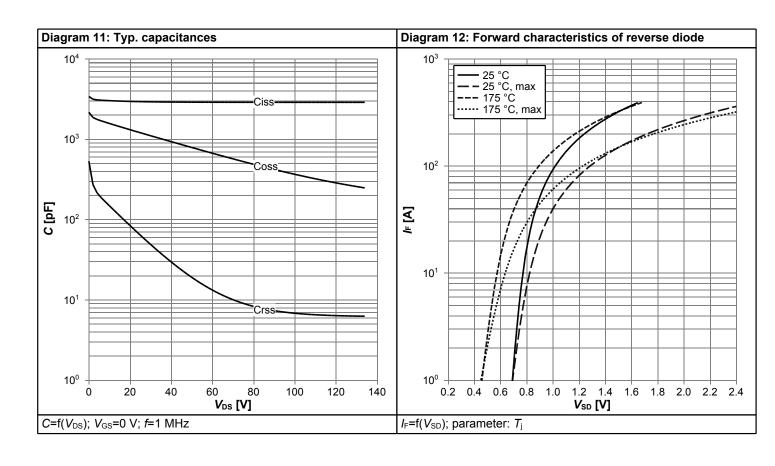




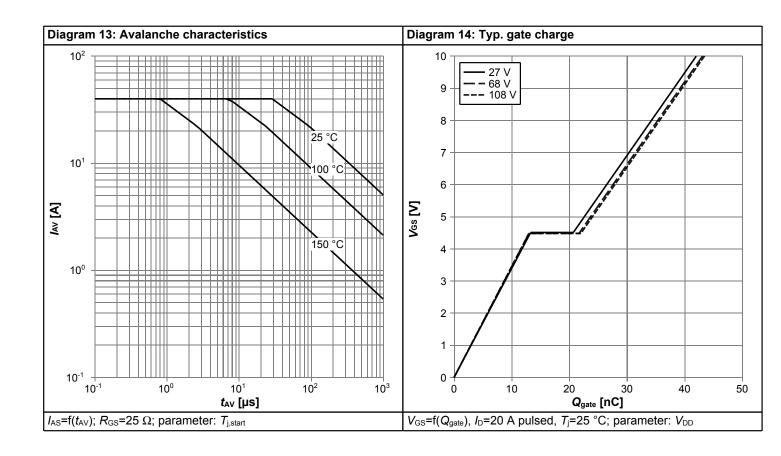


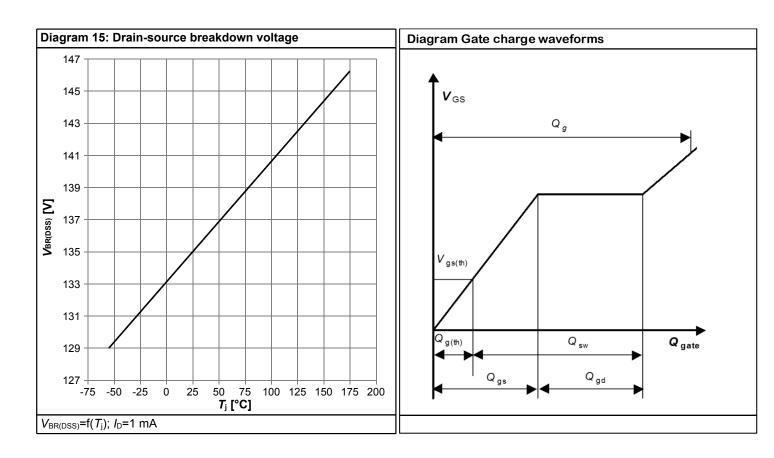






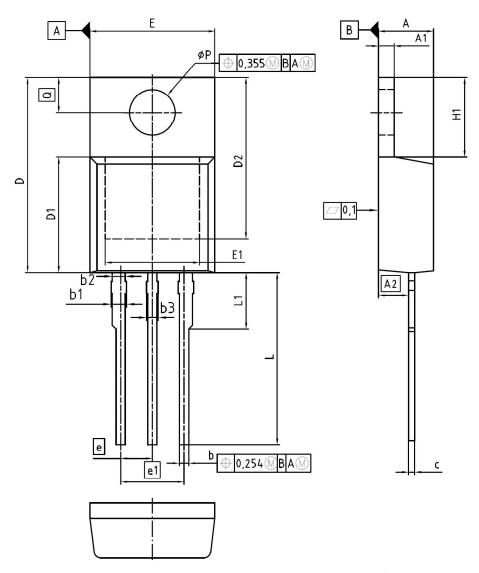








# 5 Package Outlines



DIM	MILLIM	ETERS	INCHES			
DIM	MIN	MAX	MIN	MAX		
Α	4.30	4.57	0.169	0.180		
A1	1.17	1.40	0.046	0.055		
A2	2.15	2.72	0.085	0.107		
b	0.65	0.86	0.026	0.034		
b1	0.95	1.40	0.037	0.055		
b2	0.95	1.15	0.037	0.045		
b3	0.65	1.15	0.026	0.045		
С	0.33	0.60	0.013	0.024		
D	14.81	15.95	0.583	0.628		
D1	8.51	9.45	0.335	0.372		
D2	12.19	13.10	0.480	0.516		
Ε	9.70	10.36	0.382	0.408		
E1	6.50	8.60	0.256	0.339		
е	2.5	54	0.100			
e1	5.0	08	0.200			
N		3	3	3		
H1	5.90	6.90	0.232	0.272		
L	13.00	14.00	0.512	0.551		
L1	-	4.80	-	0.189		
øΡ	3.60	3.89	0.142	0.153		
Q	2.60	3.00	0.102	0.118		

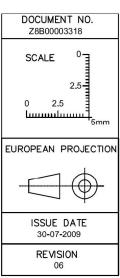


Figure 1 Outline PG-TO220-3, dimensions in mm/inches

# OptiMOS<sup>™</sup> 6 Power-Transistor, 135 V



#### **Revision History**

IPP073N13NM6

Revision: 2023-10-16, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)			
2.0	2023-10-16	Release of final version			

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